

Preliminary Technical Information

TrenchP[™] Power MOSFETs

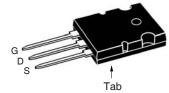
IXTK210P10T IXTX210P10T

P-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier

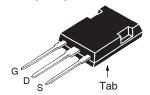


$V_{\scriptscriptstyle DSS}$	=	- 100V
I _{D25}	=	- 210A
R _{DS(on)}	≤	$7.5 \mathrm{m}\Omega$
t _{rr}	≤	200ns

TO-264 (IXTK)



PLUS247 (IXTX)



G = Gate	D = Drain
S = Source	Tab = Drain

Features

- International Standard Packages
- High Current Handling Capability
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Recitifier
- $^{\bullet}$ Low $\rm R_{\rm DS(ON)}$ and $\rm Q_{\rm G}$

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

Symbol	Test Conditions	Maximum F	Ratings
V _{DSS}	T _J = 25°C to 150°C	-100	V
V _{DGR}	$T_J = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{GS} = 1\text{M}\Omega$	-100	V
V _{GSS}	Continuous	±15	V
V _{GSM}	Transient	±25	V
I _{D25}	T _C = 25°C (Chip Capability)	- 210	A
LRMS	Lead Current Limit, RMS	-160	A
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 800	A
I _A E _{AS}	$T_{c} = 25$ °C $T_{c} = 25$ °C	-100 3	A J
dv/dt	$I_{\rm S} \le I_{\rm DM}, V_{\rm DD} \le V_{\rm DSS}, T_{\rm J} \le 150^{\circ} \rm C$	10	V/ns
P _D	T _C = 25°C	1040	W
T _J		-55 +150	°C
T _{JM}		150	°C
T _{stg}		-55 +150	°C
T _L	1.6mm (0.062 in.) from Case for 10s	300	°C
T _{SOLD}	Plastic Body for 10s	260	°C
M _d	Mounting Torque (TO-264)	1.13/10	Nm/lb.in.
F _c	Mounting Force (PLUS247)	20120 /4.527	N/lb.
Weight	TO-264 PLUS247	10 6	g g

Symbol (T _J = 25°C	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.	
BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$	-100			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250\mu A$	- 2.5		- 4.5	V
I _{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 1$	125°C		- 25 - 300	•
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$			7.5	mΩ



		teristic Values		
$(T_J = 25^{\circ}C)$	Jnless Otherwise Specified)	Min.	Тур.	Max.
\mathbf{g}_{fs}	$V_{DS} = -10V, I_{D} = -60A, Note 1$	90	150	S
C _{iss}			69.5	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		4070	pF
C _{rss}			1100	pF
t _{d(on)}	Desiration Contaction Times		90	ns
t _r	Resistive Switching Times		98	ns
t _{d(off)}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		165	ns
t _f	$R_{G} = 1\Omega$ (External)		55	ns
$Q_{g(on)}$			740	nC
Q _{gs}	$V_{GS} = -10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$		200	nC
Q_{gd}			155	nC
R _{thJC}				0.12 °C/W
R _{thCS}			0.15	°C/W

Source-Drain Diode

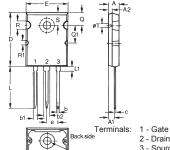
Symbol Test Conditions Characteristic		cteristic	Values		
$(T_J = 25^{\circ}C L)$	Inless Otherwise Specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			- 210	Α
I _{SM}	Repetitive, Pulse Width Limited by $T_{_{JM}}$			- 840	Α
V _{SD}	$I_{\rm F} = -100 {\rm A}, \ V_{\rm GS} = 0 {\rm V}, \ {\rm Note} \ 1$			-1.4	V
$\left\{egin{array}{c} \mathbf{t}_{rr} & \ \mathbf{Q}_{RM} \ \mathbf{I}_{RM} \end{array} ight.$	$I_F = -105A$, $-di/dt = -100A/\mu s$ $V_R = -100V$, $V_{GS} = 0V$		930 12.4	200	ns nC A

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

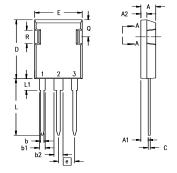
TO-264 AA Outline



2 - Drain 3 - Source 4 - Drain

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	4.82	5.13	.190	.202
A1	2.54	2.89	.100	.114
A2	2.00	2.10	.079	.083
b	1.12	1.42	.044	.056
b1	2.39	2.69	.094	.106
b2	2.90	3.09	.114	.122
С	0.53	0.83	.021	.033
D	25.91	26.16	1.020	1.030
Е	19.81	19.96	.780	.786
е	5.46 BSC		.215	BSC
J	0.00	0.25	.000	.010
K	0.00	0.25	.000	.010
L	20.32	20.83	.800	.820
L1	2.29	2.59	.090	.102
Р	3.17	3.66	.125	.144
Q	6.07	6.27	.239	.247
Q1	8.38	8.69	.330	.342
R	3.81	4.32	.150	.170
R1	1.78	2.29	.070	.090
S	6.04	6.30	.238	.248
Т	1.57	1.83	.062	.072

PLUS247™ Outline



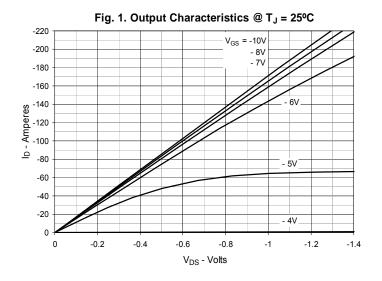
3 - Source

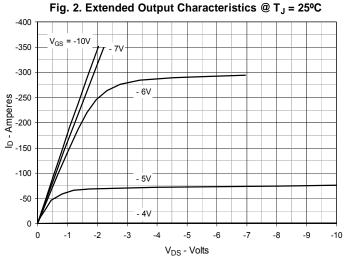
Terminals: 2 - Drain

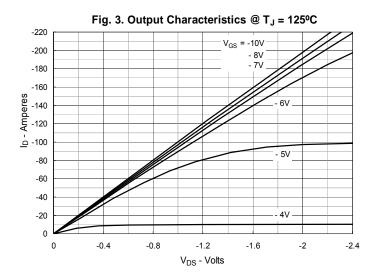
Dim.	Millimeter		Millimeter Inches	
	Min.	Max.	Min.	Max.
Α	4.83	5.21	.190	.205
A,	2.29	2.54	.090	.100
A ₂	1.91	2.16	.075	.085
b	1.14	1.40	.045	.055
b,	1.91	2.13	.075	.084
b ₂	2.92	3.12	.115	.123
С	0.61	0.80	.024	.031
D	20.80	21.34	.819	.840
Е	15.75	16.13	.620	.635
е	5.45	BSC	.215	BSC
L	19.81	20.32	.780	.800
L1	3.81	4.32	.150	.170
Q	5.59	6.20	.220	0.244
R	4.32	4.83	.170	.190

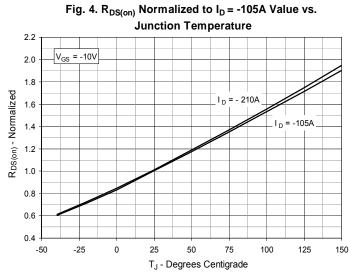
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

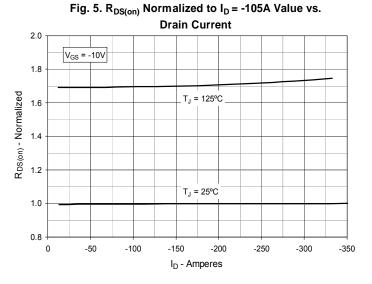


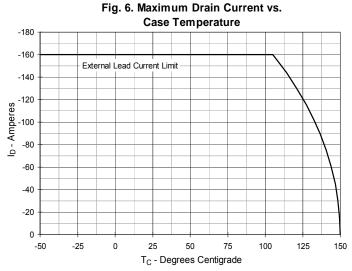




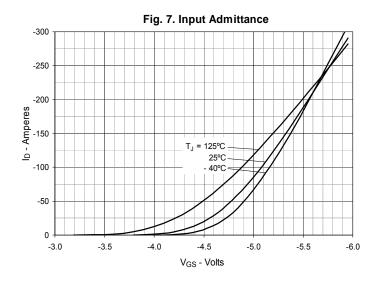


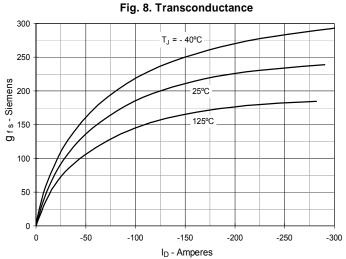


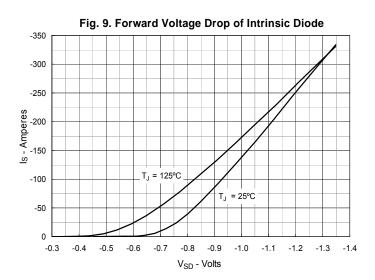


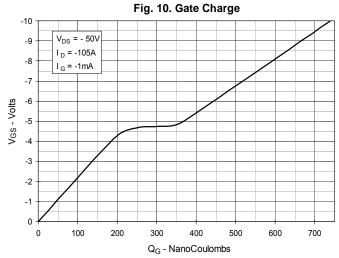


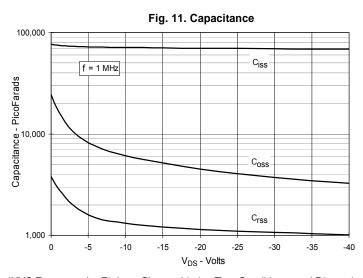


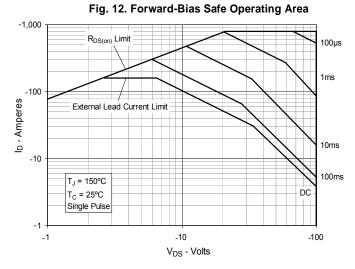












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Fig. 13. Resistive Turn-on Rise Time vs.
Junction Temperature

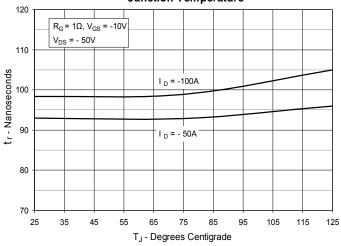


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

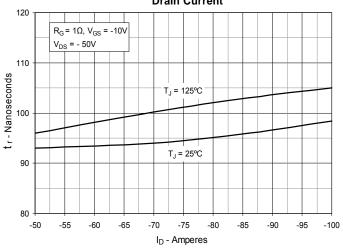


Fig. 15. Resistive Turn-on Switching Times vs.

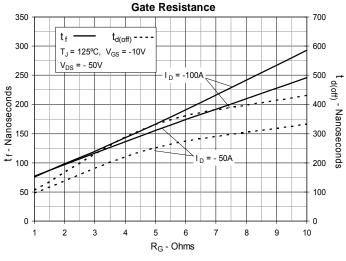
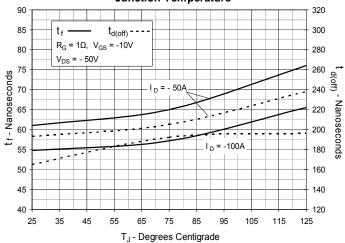


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature



 $\label{eq:Fig. 17. Resistive Turn-off Switching Times vs. } \\$

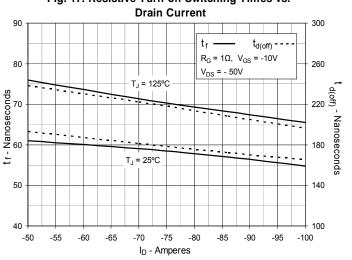
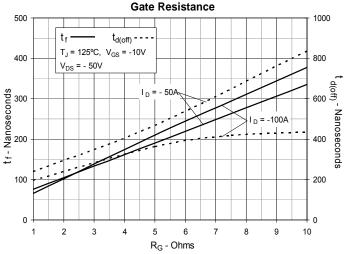


Fig. 18. Resistive Turn-off Switching Times vs.





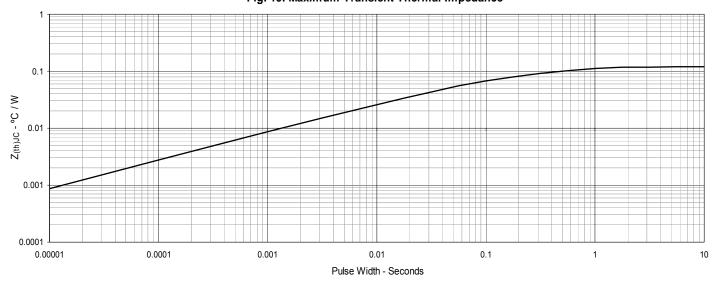


Fig. 19. Maximum Transient Thermal Impedance

